

## CDBM240-G Thru. CDBM2200-G

**Reverse Voltage: 40 to 200 Volts**

**Forward Current: 2.0 Amp**

**RoHS Device**

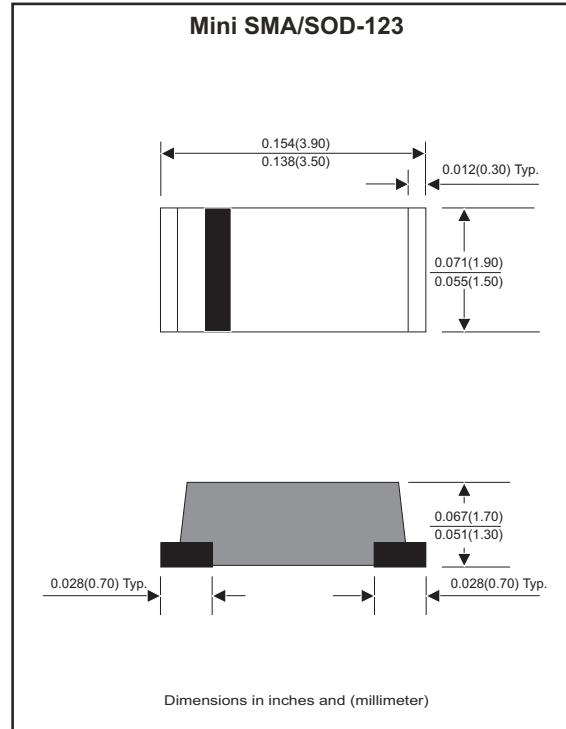


### Features

- Batch process design, excellent power dissipation offers better reverse leakage current and thermal resistance.
- Low profile surface mounted application in order to optimize board space.
- Tiny plastic SMD package.
- Low power loss, high efficiency.
- High current capability, low forward voltage drop.
- High surge capability.
- Guardring for over voltage protection.
- Ultra high-speed switching.
- Silicon epitaxial planar chip, metal silicon junction.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228

### Mechanical data

- Epoxy: UL94-V0 rated flame retardant.
- Case: Molded plastic, JEDEC Mini SMA/SOD-123.
- Terminals: Solder plated, solderable per MIL-STD-750, method 2026.
- Polarity: Indicated by cathode band.
- Mounting position: Any
- Weight: 0.018 gram(approx.).



### Maximum Ratings (at $T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	CDBM 240-G	CDBM 260-G	CDBM 2100-G	CDBM 2150-G	CDBM 2200-G	Unit
Repetitive peak reverse voltage	$V_{RRM}$	40	60	100	150	200	V
Maximum RMS voltage	$V_{RMS}$	28	42	70	105	140	V
Continuous reverse voltage	$V_R$	40	60	100	150	200	V
Forward voltage @ $I_F=2.0\text{A}$	$V_F$	0.50	0.70	0.85	0.90	0.92	V
Forward rectified current	$I_o$	2.0					A
Forward surge current, 8.3ms half sine wave superimposed on rated load (JEDEC method)	$I_{FSM}$	50					A
Reverse current on $V_R=V_{RRM}$ @ $T_A=25^\circ\text{C}$ @ $T_A=100^\circ\text{C}$	$I_R$	0.5 10					mA
Typ. thermal resistance, junction to ambient air	$R_{\theta JA}$	85					°C/W
Typ. diode junction capacitance (Note 1)	$C_J$	160					pF
Operating junction temperature	$T_J$	-55 to +125	-55 to +150				°C
Storage temperature	$T_{STG}$	-65 to +175					°C

Note 1:  $f=1\text{MHz}$  and applied 4V DC reverse voltage.

# SMD Schottky Barrier Rectifiers

**Comchip**  
SMD Diode Specialist

## Rating and Characteristic Curves (CDBM240-G Thru. CDBM2200-G)

Fig.1-Typical forward current  
current derating curve

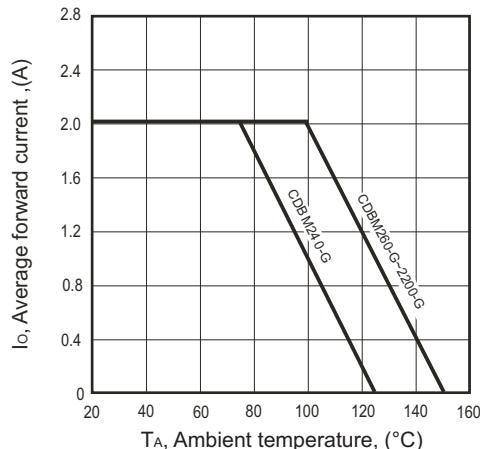


Fig.2-Typical forward characteristics

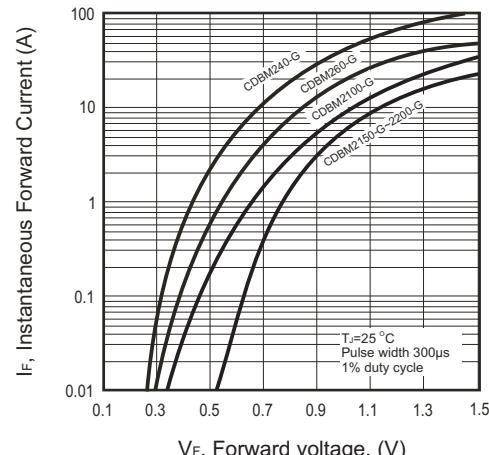


Fig.3 - Maximum non-repetitive  
forward surge current

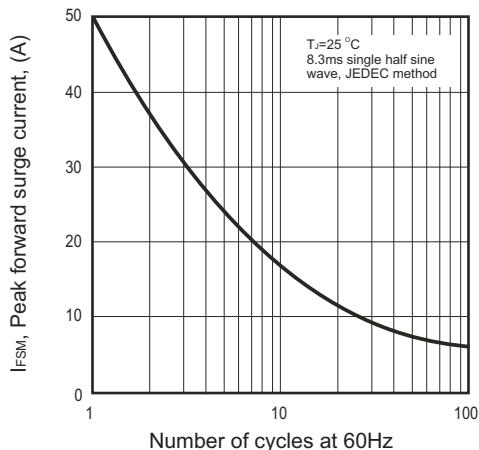


Fig.4-Typical junction capacitance

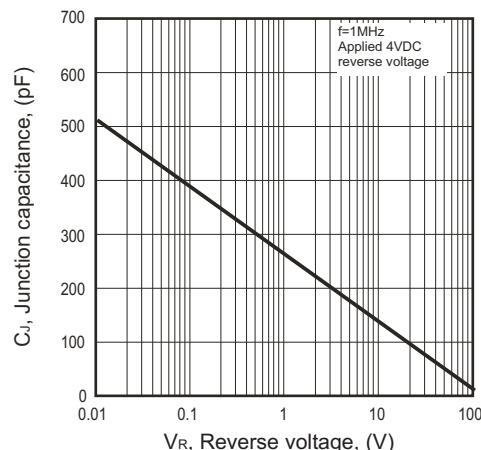
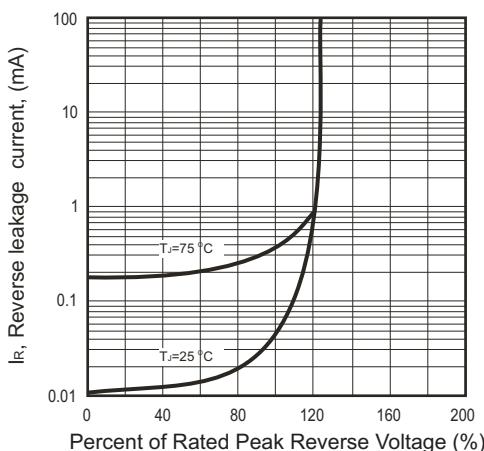
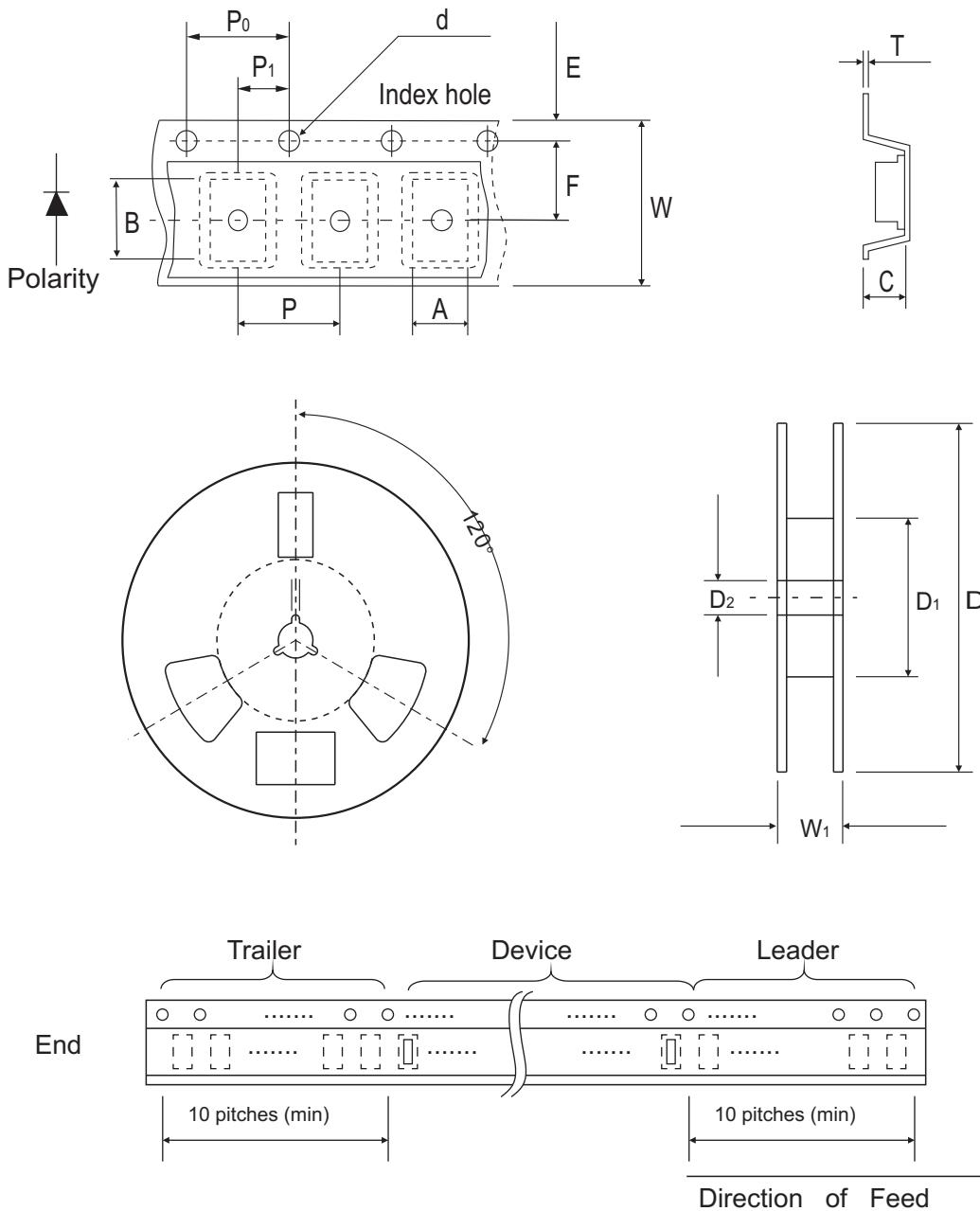


Fig.5 - Typical reverse characteristics



## Reel Taping Specification



	SYMBOL	A	B	C	d	D	D1	D2
Mini-SMA/SOD-123	(mm)	$1.90 \pm 0.10$	$3.90 \pm 0.10$	$1.68 \pm 0.10$	$1.50 \pm 0.10$	$178 \pm 2.00$	62.0 MIN.	$13.0 \pm 0.50$
	(inch)	$0.075 \pm 0.04$	$0.153 \pm 0.04$	$0.066 \pm 0.04$	$0.059 \pm 0.004$	$7.00 \pm 0.079$	2.440 MIN.	$0.512 \pm 0.020$

	SYMBOL	E	F	P	P <sub>0</sub>	P <sub>1</sub>	T	W	W <sub>1</sub>
Mini-SMA/SOD-123	(mm)	$1.75 \pm 0.10$	$3.50 \pm 0.10$	$4.00 \pm 0.10$	$4.00 \pm 0.10$	$2.00 \pm 0.10$	$0.23 \pm 0.10$	$8.00 \pm 0.30$	$14.4 \pm 0.10$
	(inch)	$0.069 \pm 0.004$	$0.138 \pm 0.004$	$0.157 \pm 0.004$	$0.157 \pm 0.004$	$0.079 \pm 0.004$	$0.009 \pm 0.004$	$0.315 \pm 0.011$	$0.567 \pm 0.004$

## Marking Code

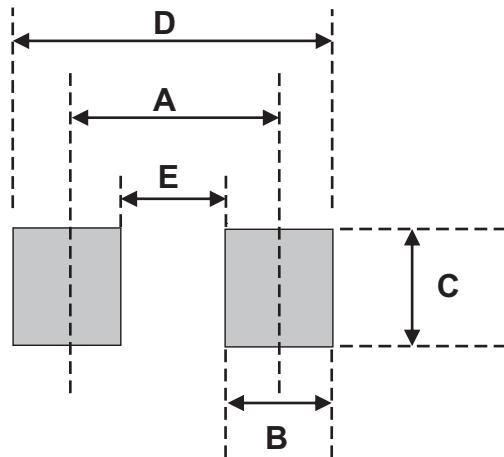
Part Number	Marking Code
CDBM240-G	24
CDBM260-G	26
CDBM2100-G	20
CDBM2150-G	215
CDBM2200-G	220



xx/xxx = Product type marking code

## Suggested PAD Layout

SIZE	Mini-SMA/SOD-123	
	(mm)	(inch)
A	3.30	0.130
B	1.40	0.055
C	1.90	0.075
D	4.70	0.185
E	1.90	0.075



## Standard Packaging

Case Type	REEL PACK	
	REEL ( pcs )	Reel Size (inch)
Mini-SMA /SOD-123	2,500	7